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System on Chips and Network on Chips	Techniques of Laser and Applications Of Electro-optics
Electrical Engineering	
Analog Circuits and Digital Circuits	Analysis of Power Quality and System Stability
Antenna and Propagation	Battery Management System
Bioinformatics & Biomedical Imaging	Biomedical Signal Processing
Brain-Computer Interfacing and Human-Computer Interfacing	Computer Relaying
Computer-Aided Surgery	Data Compression and Watermarking
Electric Energy Processing	Electro-optical Phenomena of Semiconductors
Electromagnetic and Photonics	Expert Systems
Health Care Information Systems	Healthcare Information Systems, Telemedicine
Image Processing	Information Security and Cryptography
Integrated Optics and Electro-optics Devices	Internet and web solutions for healthcare
Microwave Theory and Techniques	Microwave and millimeter circuit and Antenna
Mobile Security	Modeling, Simulation, Systems and Control
Modulation, Coding, and Channel Analysis	Multimedia Signal Processing
Natural Language Processing	Neural Networks
Parallel Programming & Processing	Power Electronics
Power IC	Remote control and techniques of GPS
Robotics and Atomization Engineering	Signal Integrity Design for High-Speed Digital Systems
Signal Processing	Simulation of Propagation
Smart Grid	Speech Analysis and Synthesis
Speech Recognition	Wireless Communication
Mechatronics	
Applications of AI Techniques in Design and Manufacturing	Diagnosis and Monitoring in Mechatronic Systems
Automation	Mechanical Engineering
Industrial Engineering	Micro-Machining
Instrumentation and Control	Mechatronics
Modeling and Design	Nano Technology
Robotics and Automation	Control, Robotics And Mechatronics
Robotics and Mobile Machines	Design and Manufacturing
Dynamic Systems and Control	Mechatronics and Intelligent Machines
Globalization of Engineering	Microsystems Integration
NanoEngineering for Energy	Nano and Micro Materials, Devices and Systems
Computer-aided design, manufacturing, and	Fault detection and Diagnosis in Mechatronics Systems

engineering	
Automobile technology	Autonomous Systems and Ambient Intelligence
Bio-Mechatronics	Machining
Design and Green Manufacturing	Intelligent Processing of Materials
Human-Machine Interface	Micro-electro Mechanical Systems and Devices
Micromachining and Microsystem technology	Micromechatronics

The conference uses double-blind review by at least two reviewers, which means that both the reviewer and author identities are concealed from the reviewers, and vice versa, throughout the review process. To facilitate this, authors need to ensure that their manuscripts are prepared in a way that does not give away their identity.

All the submitted papers will be reviewed by a minimum of two reviewers, and all the **registered** papers will be submitted to **IEEE** for potential inclusion to **IEEE Xplore** as well as other **Abstracting and Indexing (A&I) databases**. In addition, **BEST** registered papers will be published in one of the following special issues provided that the author do major improvements and extension within the time frame that will be set by the conference and his/her paper is approved by the chief editor:

			
International Journal of New Computer Architectures and their Applications (JNCAA)	International Journal of Digital Information and Wireless Communications (JDIWC)	International Journal of Cyber-Security and Digital Forensics (JCSDF)	International Journal of E-Learning and Educational Technologies in the Digital Media (JEETDM)

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